7

6

D PACKAGE (TOP VIEW)

N1/COMP

ΙΝ– Π

IN+ **∏** 3

SLOS121B - NOVEMBER 1993 - REVISED MARCH 2001

П СОМР

V_{CC+}

OUT

OFFSET N2

- Low Power Consumption
- Wide Common-Mode and Differential Voltage Ranges
- Low Input-Bias and Offset Currents
- Output Short-Circuit Protection
- Low Total Harmonic Distortion . . . 0.003% Typ
- Low Noise . . . V_n = 18 nV/√Hz Typ at f = 1 kHz
- High Input Impedance . . . JFET Input Stage
- Common-Mode Input Voltage Range Includes V_{CC+}
- Latch-Up-Free Operation
- High Slew Rate . . . 13 V/μs Typ

description

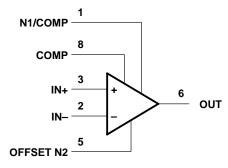
The JFET-input TL070 operational amplifier is designed as the lower-noise version of the TL080 amplifier with low input-bias and offset currents and fast slew rate. The low harmonic distortion and low noise make the TL070 ideally suited for high-fidelity and audio-preamplifier applications. This amplifier features JFET inputs (for high input impedance) coupled with bipolar output stages integrated on a single monolithic chip.

The TL070I device is characterized for operation from -40°C to 85°C.

AVAILABLE OPTIONS

		PACKAGE	
TA	V _{IO} max AT 25°C	SMALL OUTLINE (D)	
–40°C to 85°C	10 mV	TL070ID	

logic symbol†



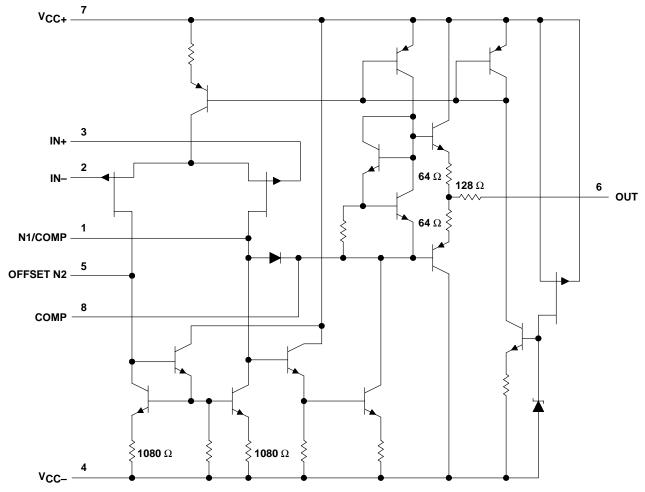
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



schematic



All component values shown are nominal.

COMPONENT COUNT				
Transistors	13			
Diodes	2			
Resistors	10			
epi-FET	1			
JFET	2			

[†] Includes all bias and trim circuitry



TL070 JFET-INPUT OPERATIONAL AMPLIFIER

SLOS121B - NOVEMBER 1993 - REVISED MARCH 2001

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC+} (see Note 1)	18 V
Supply voltage, V _{CC}	–18 V
Differential input voltage, V _{ID} (see Note 2)	±30 V
Input voltage, V _I (see Notes 1 and 3)	±15 V
Duration of short-circuit current (see Note 4)	Unlimited
Package thermal impedance, θ _{JA} (see Note 5): D package	97°C/W
PW package	149°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-}.

- 2. Differential voltages are at IN+ with respect to IN-.
- 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
- 4. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.



SLOS121B - NOVEMBER 1993 - REVISED MARCH 2001

electrical characteristics, $V_{CC\pm}$ = ±15 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T _A †	MIN	TYP	MAX	UNIT	
Vio	Input offset voltage	V _O = 0,	R _S = 50 Ω	25°C		3	10	mV	
VIO	input offset voltage	V() = 0,	NS = 30 12	Full range			13	1117	
$\alpha_{V_{IO}}$	Temperature coefficient of input offset voltage	$V_O = 0$,	$R_S = 50 \Omega$	Full range		18		μV/°C	
	Input offset surrent	V _O = 0		25°C		5	100	pA	
IIO	Input offset current	vO = 0		Full range			10	nA	
Iв	Input bias current [‡]	V _O = 0		25°C		65	200	pА	
ıВ	input bias current+	VO = 0		Full range			20	nA	
VICR	Common-mode input voltage range			25°C	±11	-12 to 15		V	
	Maximum peak output voltage swing	R _L = 10 kΩ		25°C	±12	±13.5		V	
Vом		$R_L \ge 10 \text{ k}\Omega$		Full range	±12				
		$R_L \ge 2 k\Omega$		1 ull range	±10				
A _{VD}	Large-signal differential voltage amplification	$V_O = \pm 10 \text{ V}, R_L \ge 2 \text{ k}\Omega$		25°C	25	200		V/mV	
/ VD	Large digital amereritar voltage amplification	VO = ±10 V	70 = ±10 V, KL = 2 K32		15			V/111V	
B ₁	Unity-gain bandwidth			25°C		3		MHz	
rį	Input resistance			25°C		1012		W	
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}$ $V_{O} = 0, R_{S}$		25°C	70	100		dB	
k _{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V},$ $V_{O} = 0, R_{S} = 50 \Omega$		25°C	70	100		dB	
Icc	Supply current	$V_{O} = 0$,	No load	25°C		1.4	2.5	mA	
V _{O1} /V _{O2}	Crosstalk attenuation	A _{VD} = 100		25°C		120		dB	

[†] All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified. Full range for T_A is -40°C to 85°C.

operating characteristics, $V_{CC\pm}$ = ± 15 V, T_A = $25^{\circ}C$

	PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	V _I = 10 V,	$R_L = 2 k\Omega$,	C _L = 100 pF,	See Figure 1	8	13		V/μs
	Rise-time overshoot factor	V _I = 20 mV,	D. Oko	C _L = 100 pF,	See Figure 1		0.1		μs
τ _r	Rise-time overshoot factor		N_ = 2 N22,				20		%
V Fauit	Cautivalent innut naine valtage	Do 20.0	f = 1 kHz				18		nV/√ Hz
V_{n} Equivalent input noise voltage $R_{\text{S}} = 20 \Omega$		KS = 20 12	f = 10 Hz to 10 kHz				4		μV
In	Equivalent input noise current	$R_S = 20 \Omega$,	f = 1 kHz				0.01		pA/√ Hz
THD	Total harmonic distortion	$V_{O(rms)} = 10 V,$	$R_S \le 1 \text{ k}\Omega$,	$R_L \ge 2 k\Omega$,	f = 1 kHz		0.003		%

[‡] Input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive as shown in Figure 5. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

APPLICATION INFORMATION

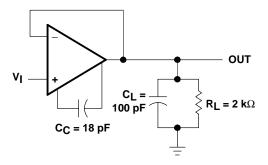


Figure 1. Unity-Gain Amplifier

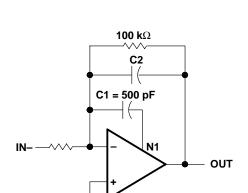


Figure 3. Feed-Forward Compensation

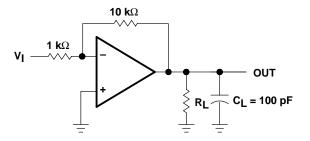


Figure 2. Gain-of-10 Inverting Amplifier

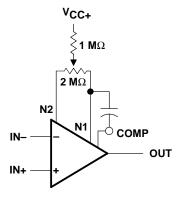


Figure 4. Input Offset Voltage Null Circuit

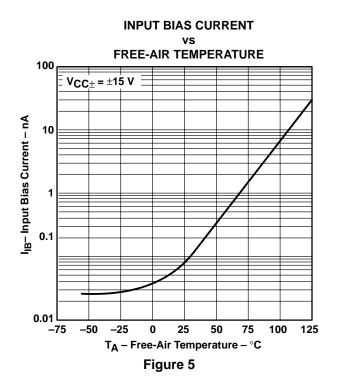
TYPICAL CHARACTERISTICS

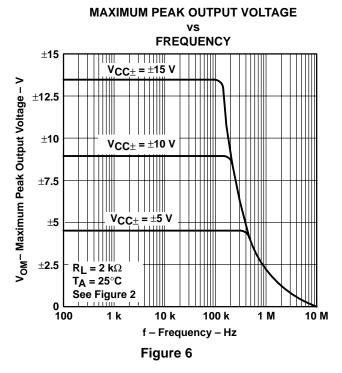
Table of Graphs

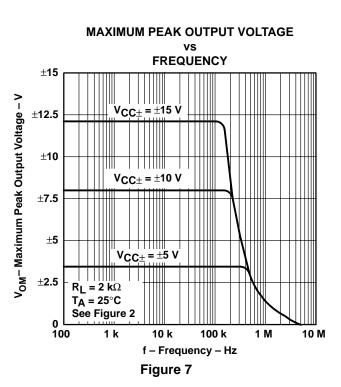
	FIGURE		
Input bias current vs Free-air temperature			
Maximum peak output voltage vs Frequency			
Maximum peak output voltage vs Free-air temperature	9		
Maximum peak output voltage vs Load resistance	10		
Maximum peak output voltage vs Supply voltage	11		
Large-signal differential voltage amplification vs Free-air temperature	12		
Differential voltage amplification vs Frequency with feed-forward compensation	13		
Large-signal differential voltage amplification and phase shift vs Frequency			
Normalized unity-gain bandwidth and phase shift vs Free-air temperature			
Common-mode rejection ratio vs Free-air temperature			
Supply current vs Supply voltage			
Supply current vs Free-air temperature	18		
Total power dissipated vs Free-air temperature	19		
Normalized slew rate vs Free-air temperature	20		
Equivalent input noise voltage vs Frequency			
Total harmonic distortion vs Frequency			
Voltage-follower large-signal pulse response			
Output voltage vs Elapsed time	24		

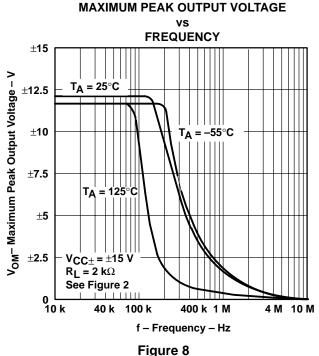


TYPICAL CHARACTERISTICS[†]





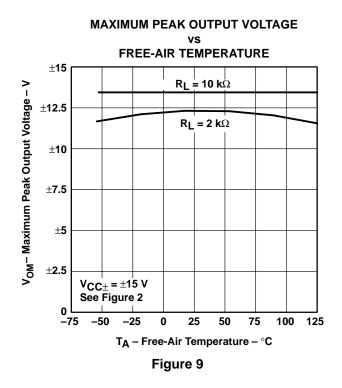


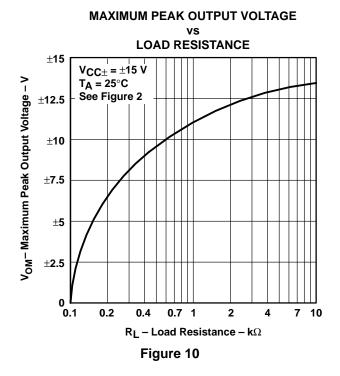


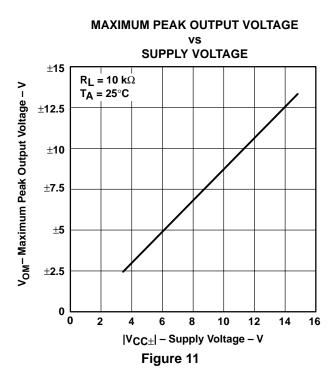
[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

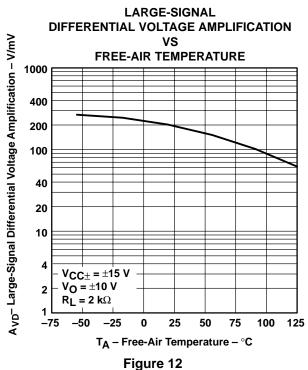


TYPICAL CHARACTERISTICS[†]









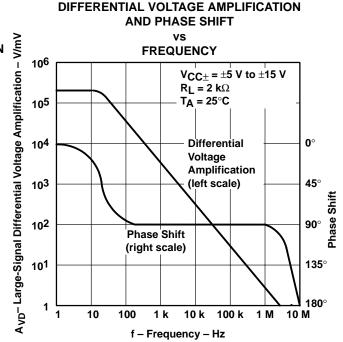
[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.



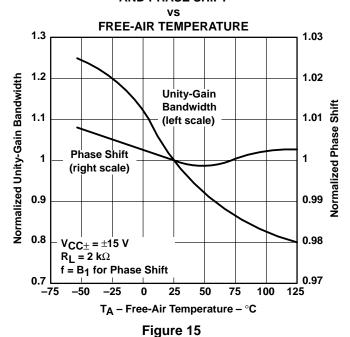
LARGE-SIGNAL

TYPICAL CHARACTERISTICS[†]

DIFFERENTIAL VOLTAGE AMPLIFICATION FREQUENCY WITH FEED-FORWARD COMPENSATION 106 A_{VD}- Differential Voltage Amplification - dB 10⁵ 104 10³ 102 $V_{CC\pm} = \pm 15 V$ C2 = 3 pF101 T_A = 25°C See Figure 3 100 1 k 10 k 100 k 1 M 100 M f - Frequency - Hz Figure 13



NORMALIZED UNITY-GAIN BANDWIDTH AND PHASE SHIFT



COMMON-MODE REJECTION RATIO

Figure 14

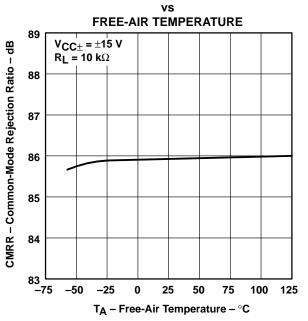
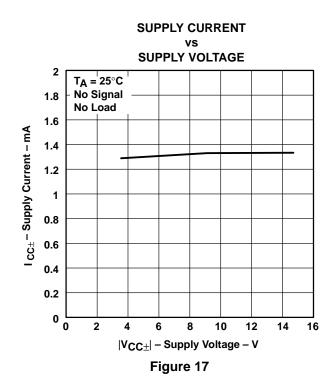


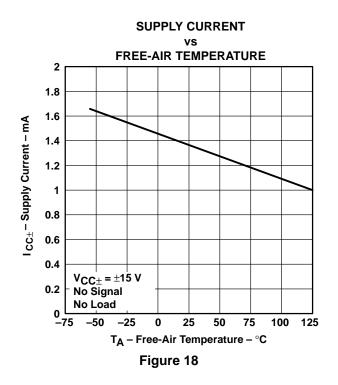
Figure 16

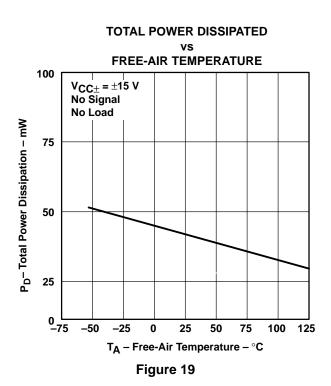
[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

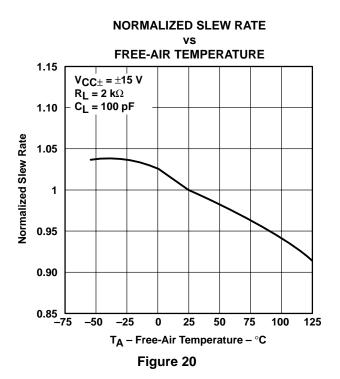


TYPICAL CHARACTERISTICS[†]





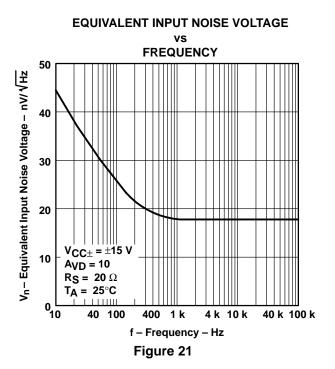


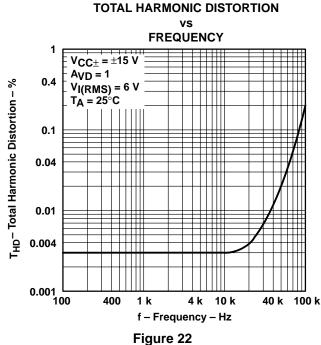


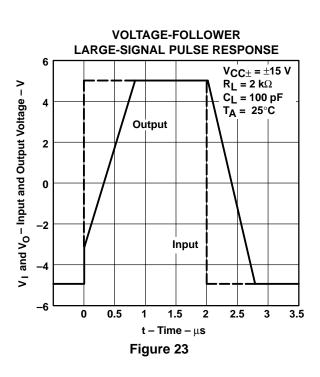
[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

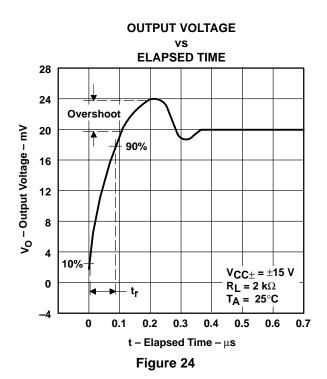


TYPICAL CHARACTERISTICS









APPLICATION INFORMATION

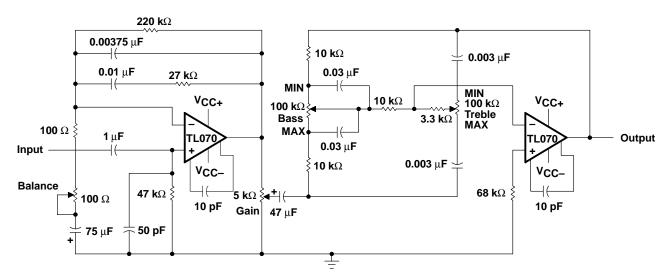


Figure 25. IC Preamplifier

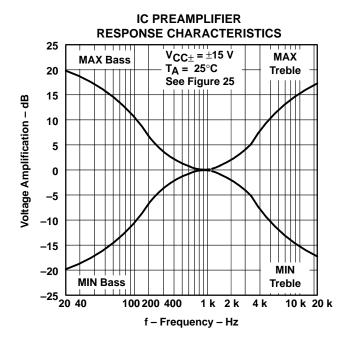


Figure 26

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PACKAGE OPTION ADDENDUM

www.ti.com 30-Jul-2009

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL070CD	OBSOLETE	SOIC	D	8	TBD	Call TI	Call TI
TL070CP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI
TL070IDR	ACTIVE	SOIC	D	8	TBD	Call TI	Call TI
TL070IDRE4	ACTIVE	SOIC	D	8	TBD	Call TI	Call TI
TL070IDRG4	ACTIVE	SOIC	D	8	TBD	Call TI	Call TI
TL070IP	OBSOLETE	PDIP	Р	8	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

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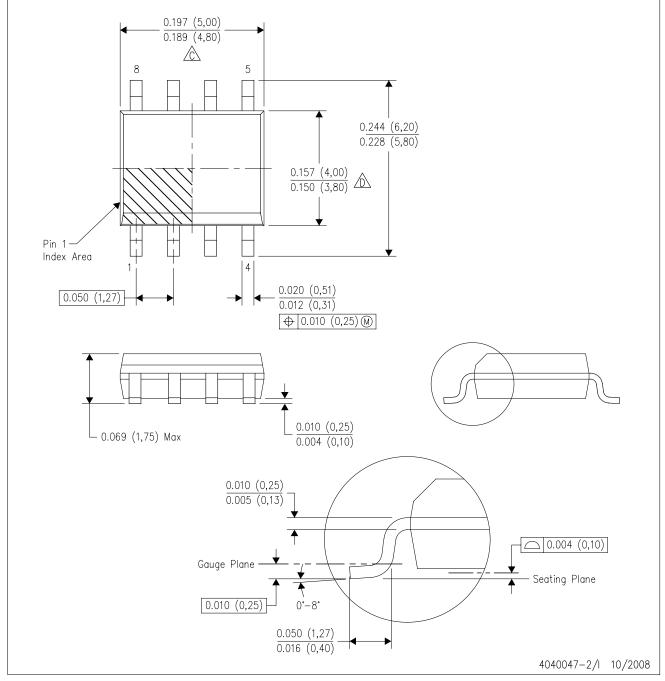
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



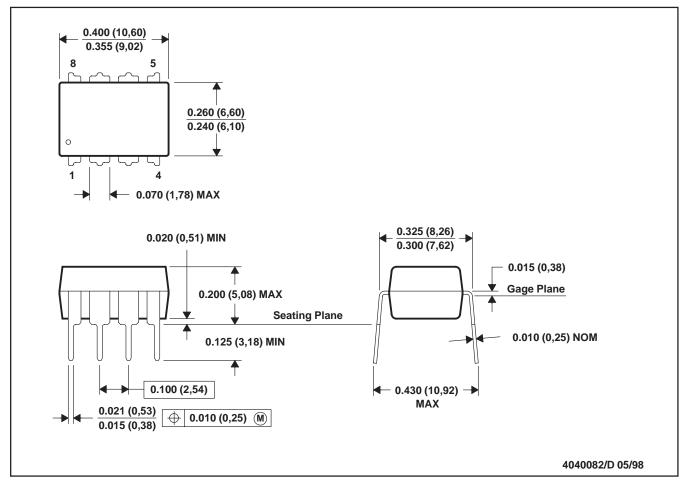
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to $http://www.ti.com/sc/docs/package/pkg_info.htm$



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